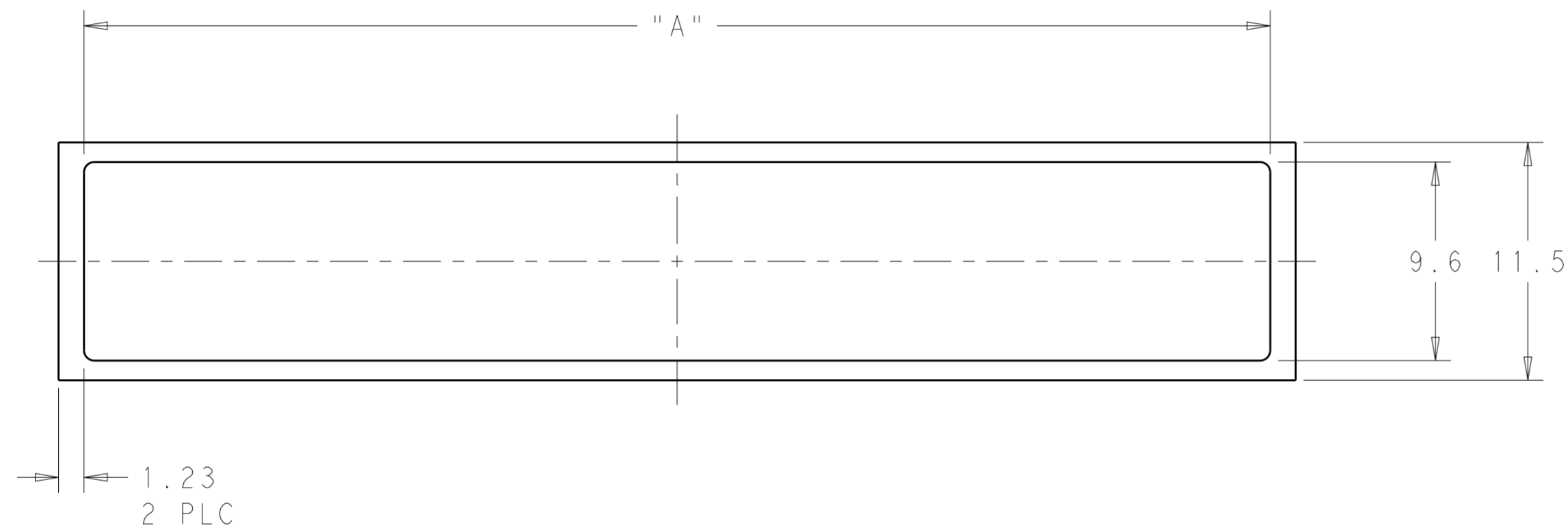


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LOC	DIST	REVISIONS					
GP	00	P	LTR	DESCRIPTION	DATE	DWN	APVD
		1		PRELIMINARY	17JAN2012	KS	AC
		2		PRELIMINARY	30MAY2012	RZ	AC
		3		PRELIMINARY	25JUN2013	ZJ	AC

1 MATERIAL: NICKEL/COPPER CONDUCTIVE FOAM WITH CONDUCTIVE ADHESIVE BACKING



DESIGN APPROVED THIS PRINT IS
PRELIMINARY
 TO FIRST PIECE APPROVAL
 CONTACT PRODUCT ENGINEERING
 BEFORE USING THIS PRINT

38.35	1X2	2170249-4
19.35	1X1	2170249-3
76.35	1X4	2170249-2
57.35	1X3	2170249-1
DIM A	APPLICATION	PART NUMBER

DIMENSIONS:		TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD		NAME	
mm		0 PLC	±0.76	DWN	KINSEN SUN	17JAN2012	TE Connectivity
		1 PLC	±0.76	CHK	DENNY ZHU	17JAN2012	SHIELDING GASKET, QSFP GANGED
		2 PLC	±0.76	APVD	ALEX CAI	17JAN2012	
		3 PLC	±0.51	PRODUCT SPEC			
		4 PLC	±	APPLICATION SPEC			
		ANGLES	±0.5°	WEIGHT			
		FINISH					
MATERIAL	1						

单击下面可查看定价，库存，交付和生命周期等信息

[>>TE Connectivity\(泰科\)](#)